

Probe Systems

Karl Suss

PA200



Semiautomatic Probe System

The SUSS PA200 Semiautomatic Probe System is available as two versions, one for high speed (HS) and one for high resolution (HR) applications. They are both very stable, modular and flexible probe systems for wafers and substrates up to 200 mm (8").

The standard ProberBench® Operating System provides ease of use and programmed automation for the most demanding analytical applications. The modular design is effective, versatile and has a defined upgrade path.

FEATURES AND BENEFITS

- ▲ Application flexibility for failure analysis, design and verification, parametric and functional tests
- ▲ Precision and stability for submicron probing
- ▲ Accommodates packaged parts and single chips as well as wafers and substrates
- ▲ Configurations for measuring from atto-Ampere level DC to 220 GHz high frequency
- ▲ Low noise and frost-free measurements from -65°C to 400°C with the SUSS ProbeShield®
- ▲ Interfaces to leading analysis instrumentation, optics, software and testers
- ▲ ProberBench operating system, fully operable with or without a PC
- ▲ Full range of accessories

SUSS. Our Solutions Set Standards.



Mask Aligners
Substrate Bonders
Flip Chip Bonders
Spin Coaters
Probe Systems

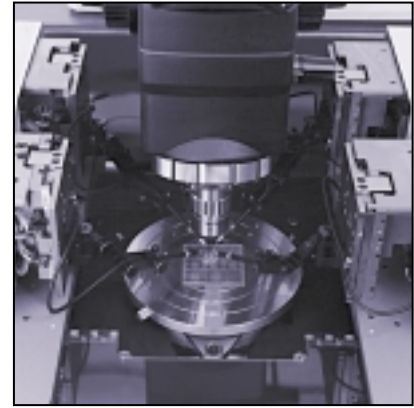
Challenges ...



Analytical DC test



High frequency test



Automated MCM test

Improve your Yield

The value of failure analysis increases as its impact on customer satisfaction, yield, quality and reliability is realized. This reliance on failure analysis, combined with greater circuit complexity and smaller structures, enhances the role of semiautomatic probers.

Versatility

Where a failure analysis lab once handled only packaged parts or wafers, it is now routinely asked to analyze a device at any stage of its lifecycle: from the wafer fab to an end user return. A prober must quickly adapt to handle products from wafers and single chips to packaged parts.

Return on Investment

The cost of failure analysis will grow, particularly for leading edge technology, necessitating higher equipment utilization and demanding a better return on investment.

Interfacing

Failure analysis, typically characterized as a hands-on procedure, manually placing probes and adjusting the device, has progressed to programmed automation for acquiring statistically relevant data across a wafer.

A prober must interface to an array of hardware and software instruments, including emission microscopes, laser cutters, data acquisition, CAD navigation software and other test equipment.

Precision

With the increase in the number of I/O pads and the decrease in feature size, a prober is expected to provide the rigidity required to use production probecards, as well as accuracy for in-circuit stepping routines. Simultaneous use of probecard and ProbeHeads to contact submicron gates is required.

Low Signal Measurements

The quality of all low-signal and sensitive measurements is dependent on the noise floor of the measurement system. All low signal measurement concerns were taken into consideration when designing SUSS probing equipment. This gives optimal noise reduction with superior performance capabilities. The PA200 system with a ProbeShield® is optimally configured for demanding low signal and frostfree low temperature testing.

The unique design of the SUSS ProbeShield guarantees a light-tight, gas tight, electromagnetic shielded, and ultra low noise environment while testing. It is ideal for ultra low signal measurements in the AttoAmp, FemtoFarad and MicroVolt range.

... and Solutions

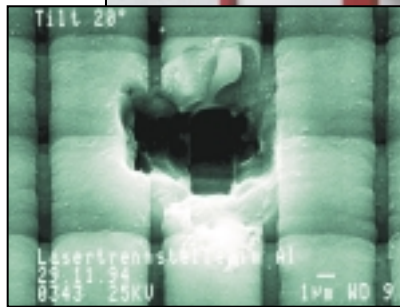


Ease of Use

Lab environments also influence the design of semiautomatic probers. In open labs with dozens of users, the prober must be simple and easy to operate. On the other hand, a prober with a dedicated user should also maximize performance.

The SUSS PA200 Semiautomatic Probe System meets these challenges through innovative design, precision and reliability.

A Graphical User Interface provided by the renowned SUSS ProberBench software makes the PA200 a fully functional, flexible yet simple tool where various set-ups can be stored for individual tasks.



Laser Cutting



A typical CAD Navigation set-up

Precise Mechanics

The SUSS PA200 Semiautomatic Probe System relies on a cast base frame and massively machined components to provide an extremely stable probing environment as well as software compensation. Precise resolution and accuracy results from using a ball-screw drive and glass scales in closed-loop positioning.

Modular Design

Modular construction provides application flexibility and cost effectiveness. Microscope mounts include fixed, manual and programmable, as well as programmable focus and magnification. ProbeHead platens are available for DC, HF and specialized applications, with fixed or manual movement.

The standard chuck secures single chips to 8" wafers; optional chucks handle fragile III-V compound wafers and rectangular substrates.

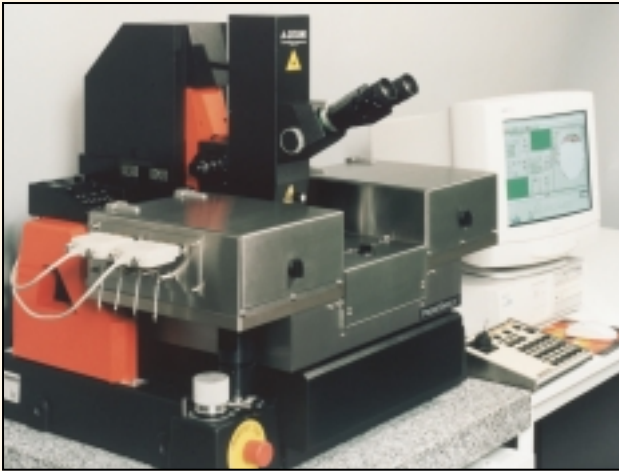
Adaptation to the height differences between wafers and packaged parts is accomplished by the chuck and platen having 30/15 (HR/HS) and 20 mm of travel respectively, for approx. 50 mm (2") of working clearance. DUT boards are secured by vacuum to the standard wafer chuck, so chuck planarity is not affected.

User-Friendly

The ProberBench® Operating System is a powerful multi-tasking system with joystick controller, graphical and remote interfaces. The Windows® based graphical interface includes Navigator on-screen joystick and setup, TableView spreadsheet, graphical WaferMap and optical VideoTracker navigation and data acquisition modules. Standard remote interfaces are IEEE488 and RS232. The prober is fully operable without a PC.



Application flexibility



PA200 with ProbeShield® EMC for low signal and low temperature probing

Application flexibility is defined by the diversity of applications, as well as the specific requirements of each. There are many aspects to consider: Measurement type and integrity, integration into a test system and how the user interacts with the system as well as mechanical stability and accuracy. SUSS addresses these issues with a modular or customer specific design and with our wide range of accessories.

DC Parameter testing

For DC parametrics, the software can be configured as a simple, easy to use interface for scanning a wafer during fast step-and-repeat patterns. Hardware choices include high pin-count probecard adapters, triaxial probes, chucks (standard and thermal), and the SUSS ProbeShield® for low current and capacitance measurements. The unique *Quiet Mode* removes power to all motors to reduce the noise floor. SUSS precision allows the reliable, automatic probing of transistors and the smaller pads of monitor chips.

Failure Analysis

For failure analysis mechanical versatility provides quick changeover between packaged parts and wafers. The ProberBench operating system has been integrated with the most common failure analysis tools, including emission microscopes, CAD navigation software, laser cutters and

data acquisition/analysis software. All ProbeHeads can be simultaneously used with a probecard and with active probes. SUSS stability allows the smallest features to be easily probed at the highest magnifications, especially when used with the SUSS MFI Probe for scanning and probing below 0.2 μm .

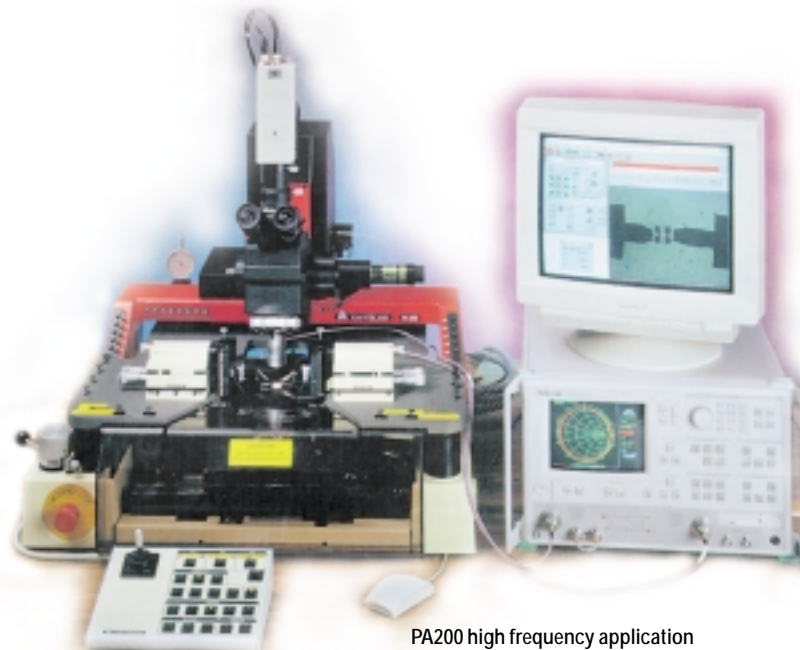
High Frequency

The SUSS PA200 has the stability for HF on-wafer probing without compromising flexibility. A complete range of accessories for probing up to 220 GHz is available and includes: Probes, calibration substrates and software, positioners, chucks, cables and IC-CAP interfacing.

Temperature Probing

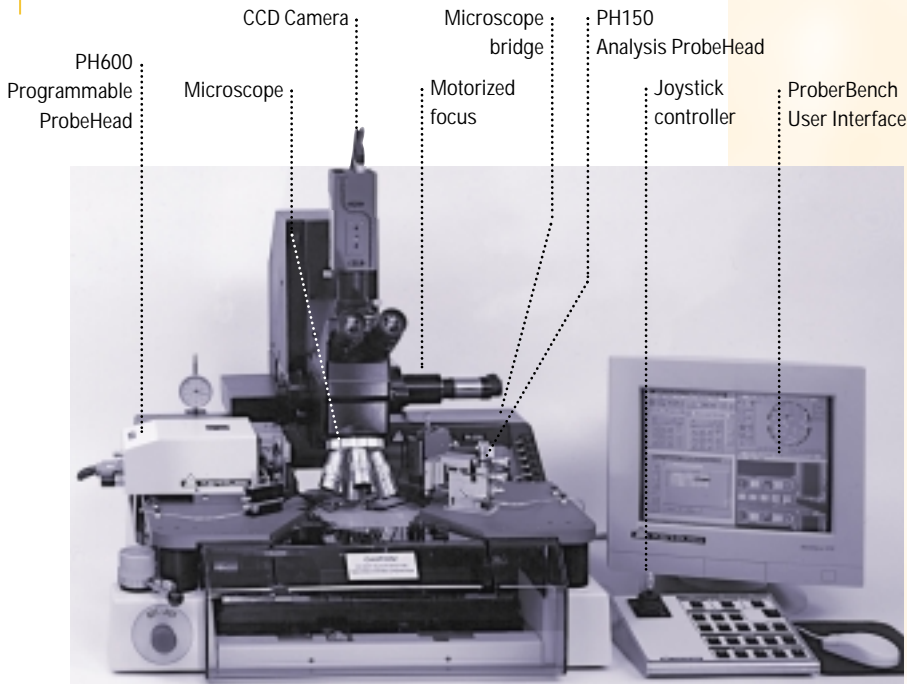
The SUSS ProbeShield also provides an innovative approach to probing down to -65°C . Frost-free low temperature probing requires that the air surrounding the cold chuck is pressurized, clean and dry. Just enough pressure is required to keep the ambient air out of the chamber. The air is dried so that its dew point is lower than the chuck temperature.

For thermal low signal applications, SUSS supplies a range of low leakage thermal chucks up to 300°C .



PA200 high frequency application

The Design



SUSS PA200 Semiautomatic Probe System

The prober mechanics are based on a web-reinforced, aluminum casting for excellent rigidity and vibration damping. The wrap-around design places the stage and platen drives into, rather than on top of, the base further increasing stability. All surfaces are finished in cleanroom grade paint or are anodized.

The **X-Y stage** is constructed of steel for temperature stability. Linear accuracy and torsional stiffness are enhanced with wide spaced bearings and the use of ground in place of the more typical rod and ball slides. A ball-screw drive is utilized which automatically compensates for wear and ensures the system will remain backlash-free. The DC servo closed loop positioning system uses linear encoders to read the actual stage position and to preclude leadscrew induced thermal errors. In addition to the superior mechanical design, two software compensation routines are used: linear and matrix. "Linear" adjusts positioning by an equal amount over the 200 mm travel range and can be used to correct thermal chuck induced wafer expansion/contraction. "Matrix" maps the stage throughout its travel for finer accuracy. Axes orthogonal error is also compensated. The Z and theta axes are DC servo closed loop driven.

The **microscope** is supported by a cast aluminum bridge for stability at the highest magnifications. The bridge design allows rearward access for cable routing. The cantilevered load of a microscope is a design challenge addressed by using bearing ways. The programmable microscope movement closed loop DC servo drive provides 50 mm of travel. Software compensation is used, and is aligned to the chuck stage for parallel movement between the stages. Programmable focus, and magnification on some microscope models, is also available.

The **ProbeHead Platen** is the most versatile component of a prober. For DC applications the material is typically aluminum which is hard-coated for durability and uses vacuum hold-down. High frequency applications require greater rigidity, therefore steel is used for magnetic, bolt-down and kinematic mounting. Probecard adapters are available for all platens. Although the platen can be mounted in a fixed position, a manual drive mechanism is more commonly used. The mechanism consists of four columns with ball-cage bearings providing an extremely stable, linear and repeatable movement. The drive knob, conveniently located at the left front corner, provides a fine 400 μm contact/separation stroke, as well as 20 mm of coarse travel for adjusting to test fixturing and thermal chucks.

The mechanics are controlled by the SUSS **ProberBench Operating System** consisting of the drive electronics, joystick controller and Windows user interface. Interfacing flexibility is provided with an IEEE488 port in the electronics and an IEEE488 and an RS232 port in the PC. All ports can be used simultaneously. This is the same for all SUSS Probe Systems.



Flexible and versatile

Drive Electronics

The drive electronics which use standard SUSS components are housed in a standard 6×19" cabinet. As a separate unit there is greater flexibility. Furthermore the mechanics are smaller and electrically quieter.

All motorized prober functions are integrated at the electronics, so there are no additional boxes or controllers. In addition to the chuck and microscope stages, up to four ProbeHeads and two contact sense cards can be accommodated.

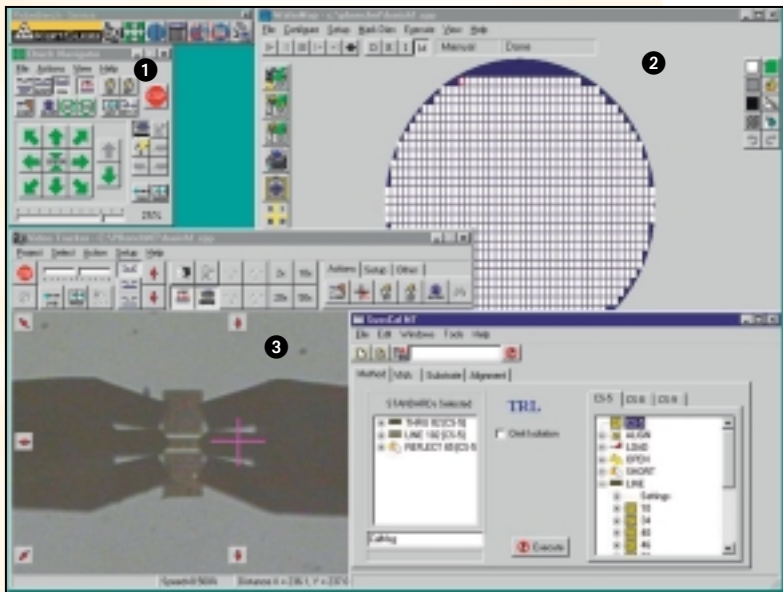
The system complies with leading guidelines, including SEMI S2-93, IEC 204-1 and EC-Low Voltage Directive (CE-Mark) and EN61010-1.

Joystick Controller

The joystick controller is solidly constructed of stainless steel and uses rotary encoders for proportionally precise, uni- or bi-directional control. It is more than a simple joystick controller, providing full prober functionality via fixed and LED-defined programmable keys. Included are two-point theta alignment, setting index, home and contact, as well as go load and scope lift are provided.

User Interface

The Windows® user interface consists of joystick, spreadsheet, graphical and video control modules.



ProberBench within the SUSSCAL Calibration Software

The **Navigator** ❶ on-screen joystick provides navigation by mouse and the entry of all setup parameters.

Table View controls stage movement by coordinates, which are in spreadsheet format and are entered by recording the current position, keyboard, pasting and importing. Up to 96 columns are available for test results, binning or comments.

The graphical **WaferMap** ❷ can be used to quickly move to dies using coordinates or as part of an automated test routine and has sub-site probing capability.

VideoTracker ❸ conveniently displays a video image in a window of the PC monitor and has the ability to save the image to disk. Chuck, microscope and ProbeHead positioning is as simple as clicking on the image.

All setup parameters are contained in project files, whereas the data from the Table View and WaferMap modules is saved in ASCII-format files for easy transfer to and from other instruments. Temperature compensations are no longer necessary as separate wafer maps with different temperature settings can be stored for the same project.

This electronic rack, joystick controller and user interface combination is common to all SUSS programmable Probe Systems, thus reducing the learning curve and ensuring compatibility of instrument and software drivers.

The PA200 modular Probe System



Microscope stages

Stage type	Travel	Resolution	Access lift options	Recommended microscope	Application
Programmable	50×50 mm	0.25 µm	Standard 80 mm pneumatic or 130 mm motorized	High magnification or stereo view	Internal die navigation and remote control
Manual	50×50 mm	40 mm/rev.	Fixed, manual or pneumatic tilt-back	High magnification or stereo view	Internal die
High resolution manual	50×50 mm	0.25 mm/rev	Fixed, manual or pneumatic tilt-back	High magnification	Internal die and laser cutting
Adjustable	30×30 mm		Fixed	Stereo view	Minimal movement required

Microscopes

Microscope type	Models available	Application
Stereo view	Olympus SZ4045 Series, Leica M5-12 Series	Pad probing and internal features down to 5 µm
High magnification w/out Eyepieces	Mitutoyo FS-70 Series, A-Zoom Optem	Offers the most flexibility and options for features down to 0.5 µm HF applications and use with TV systems

ProbeHead platens

PH Mounts	Application
Vacuum	Most common, offers ease of use and flexibility
Magnetic	Offers more rigidity than vacuum. Commonly used when magnetic base ProbeHeads are already used
Mechanical	Mechanical T-nut mount providing high rigidity
HF Universal	Offers vacuum, magnetic, bolt down and kinematic mounting. Kinematic requires additional kit
Customized	Custom designs are available for specialized applications, such as testhead docking, substrates and MCM test

Software interfaces

Application	Vendors
CAD Navigation	Knights Technology, Schlumberger, Raith
Emission Microscopy	Hypervision, Hamamatsu, EDO Barnes
Data Acquisition	Metrics ICV, NI LabView, Lab Windows/CVI, Keithley, TestPoint, Mosaid, Agilent VEE
Design and Modeling	Agilent IC-CAP, Silvaco
Programming	MS Visual Basic, C++, Delphi
Laser Cutting	New Wave Research
Thermal Chucks	Temptronic, ERS, Trio Tech

Accessories

Probes: Active, passive, HF, triaxial, coaxial, low impedance, Kelvin

Probe tips: Tungsten, tungsten-carbide, palladium, copper shaft

Probecards: SUSS supports all major probecard manufacturers

Manual ProbeHeads: Contacting bond pads & internal nodes down to 1 µm

Remote controlled ProbeHeads: For submicron probing, programmable

ShieldEnclosure SE1000: Light-tight or EM-shielded versions

Laser cutter: Depassivating, cutting traces, trimming and blowing fuses

Ultrasonic cutter: Depassivating brittle materials

Utility pumps: Vacuum, pressure or combinations

Standard chucks: From 4" to 8" (100–200 mm), usually made of stainless steel

Triaxial chucks: For low-signal measurements

High insulation chucks: Power device test, low capacitance demands

Microwave chucks: Designed for brittle III-IV compounds and high measurement stability. Auxiliary chucks for calibration and burnishing substrates

Thermal chucks: Adaptor kits for all hot chucks on the market available

ProbeShield®: Completely light-tight, gas-tight and EM-shielded design for low-signal and frost-free low temperature probing

Material handling: Provides system automation, as well as eliminates user handling, and possible damage to wafers

Pattern recognition: Complete system automation for cassette-to-cassette operation, vision module

Packaged device holders: Held down by vacuum on the chuck's surface

Fixtures and chuck accessories: Quickly manufactured to hold down substrates, provide alignment pins, or allow bottom side probing

Chuck surfaces: Standard: stainless steel. Options: gold plated, Teflon coated, aluminum hard coated, nickel plated

Camera and monitors: Facilitates contact bond pads or internal nodes

Tables: Vibration isolation tables VIT 800, 801, 802, depending on application



PA200 HR/HS Semiautomatic Probe System

Chuck Stage

X-Y Movement

Closed-loop, DC servo with linear encoder feedback	HR	HS
Travel	200×200 mm	200×200 mm
Resolution	0.5 µm	1.0 µm
Repeatability	± 1.0 µm	± 2.0 µm
Accuracy	± 1.5 µm	± 5.0 µm
Planarity	8 µm	8 µm
Maximum speed	50 mm/sec	100 mm/sec

Z Movement

DC servo with rotary encoder feedback	HR	HS
Travel	30 mm	15 mm
Resolution	0.25 µm	0.25 µm
Repeatability	±1.0 µm	±1.0 µm

Theta Movement

DC servo with rotary encoder feedback	
Travel	± 6.0°
Resolution	0.0001°

Programmable Microscope Movement

DC servo with rotary encoder feedback	
Travel	50×50 mm
Resolution	0.25 µm
Repeatability	± 1.0 µm
Accuracy	± 2.5 µm
Access lift	80 mm pneumatic or 130 mm motorized

Manual Platen Movement

Drive type	Compound knob
Contact/separation stroke	0.4 mm linear
Coarse adjustment	20 mm

Graphical User Interface

Windows 2000 or NT based

Remote Interfaces

PC	RS232, IEEE488
Electronics	IEEE488

Utilities

Power	115/230 V, 50/60 Hz, 500 W
Vacuum	Less than 200 mbar abs
Compressed air	4 bar min
Vacuum/air inputs	6 mm, 1/4" (USA)

Dimensions (W×D×H)

Mechanic (microscope in raised position)	742×815×770 mm, 29×32×30"
Electronics (with connectors installed)	520×600×160 mm 20.5×23.5×6.3"

Joystick controller

(with connector installed)	260×260×120 mm 1.3×10.3×4.7"
----------------------------	---------------------------------

Weight

Mechanics	133 kg, 300 lb
Electronics	13 kg, 28 lb

Data depends on individual process conditions and will vary according to equipment configurations

Karl Suss Worldwide

North America

KARL SUSS America, Inc.
228 Suss Drive · Waterbury Center, VT 05677 · USA
Phone (802) 244-5181 · Fax (802) 244-5103

KARL SUSS America, Inc.
Regional Sales + Service Center
8240 S. Kyrene Road · Suite 101 · Tempe, AZ 85284 · USA
Phone (480) 557-9370 · Fax (480) 557-9371

KARL SUSS America, Inc.
Regional Sales + Service Center
2694 Orchard Parkway · San Jose, CA 95134-2020 · USA
Phone (408) 432-3071 · Fax (408) 432-3072

Germany

KARL SUSS KG GmbH & Co.
Schleissheimer Strasse 90 · D-85748 Garching b. München · Germany
Phone (+49)-[0] 89/3 20 07-0 · Fax (+49)-[0] 89/3 20 07-162

KARL SUSS Dresden GmbH
Süss - Strasse 1 · D-01561 Sacka b. Dresden · Germany
Phone (+49)-[0] 35240-73-0 · Fax (+49)-[0] 35240-73-700

KARL SUSS Vaihingen GmbH
Planckstr. 9 · D-71665 · Vaihingen/Enz · Germany
Phone (+49)-[0] 7042 / 955-0 · Fax (+49)-[0] 7042 / 955-100

France

KARL SUSS France S.A.
Avenue des Colombières · F-74490 Saint Jeoire · France
Phone (+33) [0] 4 50 35 83 92 · Fax (+33) [0] 4 50 35 88 01

Great Britain

KARL SUSS Great Britain Ltd.
23 Ivanhoe Road · Hogwood Lane Industrial Estate
Finchampstead · Wokingham · Berkshire
GB · RG40 4QQ · England
Phone (+44) [0] 11 89-732144 · Fax (+44) [0] 11 89-734395

Japan

KARL SUSS Japan K.K.
カール・スース・ジャパン株式会社
〒226-0006 神奈川県横浜市緑区白山1-18-2
ジャーマン・インダストリー&トレード・センター
GITC 1-18-2, Hakusan, Midori-ku · Yokohama, Kanagawa 226-0006
Phone (+81)-45-931-5600 · Fax (+81)-45-931-5601

Asia

KARL SUSS Asia Co., Ltd.
212/2 Soi Ladprao 10
Ladprao Road, Ladyao · Jatujak · Bangkok 10900 · Thailand
Phone (+66)-2 938 44-26, -27 · Fax (+66)-2 512 5569

Come visit our website!

www.suss.com

Representatives in over 30 countries. Please ask for our address list.

SUSS. Our Solutions Set Standards.

